


 Click [here](#) for the 3D model.

General Information

| | |
|----------------|--|
| Series | SMD MIL COG PRF32535 |
| Style | SMD Chip |
| Description | SMD, Low ESR, MIL-PRF-32535 |
| RoHS | No |
| Prop 65 | WARNING: Cancer and reproductive harm - https://www.p65warnings.ca.gov/ |
| SCIP Number | d66873f5-e54d-410c-a0cf-ebf6fcf635b5 |
| Termination | Solder Plated |
| Failure Rate | N/A |
| Qualifications | MIL-PRF-32535 M-Level |
| Shelf Life | 78 Weeks |
| MSL | 1 |

Dimensions

| | |
|----------------------|---------------------|
| L | 2.01mm +0.3/-0.25mm |
| W | 1.27mm +0.3/-0.25mm |
| T | 1.57mm MAX |
| B | 0.51mm +/-0.25mm |
| Case Code (EIA / mm) | 0805 / 2012 |

Packaging Specifications

| | |
|--------------------|--------|
| Packaging | Waffle |
| Packaging Quantity | 100 |

Specifications

| | |
|--|------------------------|
| Capacitance | 100 pF |
| Tolerance | 5% |
| Voltage DC | 200 VDC |
| Dielectric Withstanding Voltage | 500 VDC |
| Temperature Range | -55/+125°C |
| Temp. Coefficient | COG |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 30 ppm/C, 1MHz 1.0Vrms |
| Dissipation Factor | 0.15% 1 MHz 1.0Vrms |
| Aging Rate | 0% Loss/Decade Hour |
| Insulation Resistance | 100 GOhms |

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